## ZFUSE.RU

## Summary

- RoHS Compliant (Lead Free) Product
- Applications: Wide variety of electronic equipment
- Product Features: Low hold current, Solid state, Radial leaded product ideal for up to 30 V
- Operation Current: 5.0A
- Maximum Voltage: 30 V
- Temperature Range : $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$


## Electrical characteristics $\left(23^{\circ} \mathrm{C}\right)$

| Part <br> Number | Hold <br> Current | Trip <br> Current | Max.Time <br> to Trip | Maximum <br> Current | Rated <br> Voltage | Typical <br> Power | Resistance <br> Tolerance |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | IH, A | IT, A | at 5xIH | IMAX, A | VMAX, Vdc | Pd, W | ohms | RMAX |
| 30 Z 500 | 5.0 | 10.0 | 14.5 | 40 | 30 | 3.0 | 0.01 | 0.03 |

It - Hold current-maximum current at which the device will not trip at $23^{\circ} \mathrm{C}$ still air.
IT - Trip current-minimum current at which the device will always trip at $23^{\circ} \mathrm{C}$ still air.
Vmax - Maximum voltage device can withstand without damage at its rated current.
Imax - Maximum fault current device can withstand without damage at rated voltage (Vmax).
Pd - Typical power dissipated from device when in tripped state in $23^{\circ} \mathrm{C}$ still air environment.
Rmin - Minimum device resistance at $23^{\circ} \mathrm{C}$.
R1max - Maximum device resistance at $23^{\circ} \mathrm{C}, 1$ hour after tripping .
Physical specifications:
Lead material: Tin plated copper, 24 AWG.
Soldering characteristics: MIL-STD-202, Method 208E.
Insulating coating: Flame retardant epoxy, meets UL -94V-0 requirement.

## Production Dimensions (millimetre)



| Part <br> Number | $\mathbf{A}$ | $\mathbf{B}$ | $\mathbf{C}$ | $\mathbf{D}$ | E | Lead |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Maximum | Maximum | Typical | Minimum | Maximum | Ф |
| $30 Z 500$ | 14 | 24.9 | 3.0 | 7.6 | 10.2 | 0.8 |

Thermal Derating Curve


Typical Time-To-Trip at $23^{\circ} \mathrm{C}$


